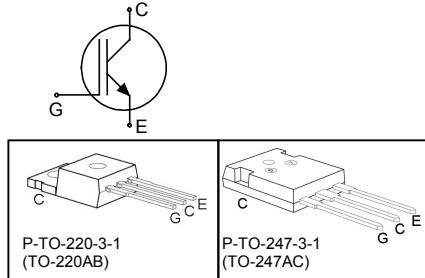


## High Speed IGBT in NPT-technology

- 30% lower  $E_{off}$  compared to previous generation
- Short circuit withstand time – 10  $\mu$ s
- Designed for operation above 30 kHz
- NPT-Technology for 600V applications offers:
  - parallel switching capability
  - moderate  $E_{off}$  increase with temperature
  - very tight parameter distribution
- High ruggedness, temperature stable behaviour
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>



Type	$V_{CE}$	$I_C$	$E_{off}$	$T_j$	Package	Ordering Code
SGP20N60HS	600V	20	240 $\mu$ J	150°C	TO220AB	Q67040-S4498
SGW20N60HS	600V	20	240 $\mu$ J	150°C	TO-247AC	Q67040-S4499

### Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage $T_C = 25^\circ\text{C}$	$V_{CE}$	600	V
DC collector current $T_C = 25^\circ\text{C}$	$I_C$	36	A
$T_C = 100^\circ\text{C}$		20	
Pulsed collector current, $t_p$ limited by $T_{jmax}$	$I_{Cpuls}$	80	
Turn off safe operating area $V_{CE} \leq 600\text{V}, T_j \leq 150^\circ\text{C}$	-	80	
Avalanche energy single pulse $I_C = 20\text{A}, V_{CC}=50\text{V}, R_{GE}=25\Omega$ start $T_J=25^\circ\text{C}$	$E_{AS}$	115	mJ
Gate-emitter voltage static transient ( $t_p < 1\mu\text{s}, D < 0.05$ )	$V_{GE}$	$\pm 20$ $\pm 30$	V
Short circuit withstand time <sup>1)</sup> $V_{GE} = 15\text{V}, V_{CC} \leq 600\text{V}, T_j \leq 150^\circ\text{C}$	$t_{SC}$	10	$\mu\text{s}$
Power dissipation $T_C = 25^\circ\text{C}$	$P_{tot}$	178	W
Operating junction and storage temperature	$T_j, T_{stg}$	-55...+150	$^\circ\text{C}$
Time limited operating junction temperature for $t < 150\text{h}$	$T_{j(tl)}$	175	
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260	

<sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

**Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
<b>Characteristic</b>				
IGBT thermal resistance, junction – case	$R_{thJC}$		0.7	K/W
Thermal resistance, junction – ambient	$R_{thJA}$	TO-220AB TO-247AC	62 40	

**Electrical Characteristic**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	

**Static Characteristic**

Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0\text{V}, I_C=500\mu\text{A}$	600	-	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE} = 15\text{V}, I_C=20\text{A}$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$		2.8 3.5	3.15 4.00	
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C=500\mu\text{A}, V_{CE}=V_{GE}$	3	4	5	
Zero gate voltage collector current	$I_{CES}$	$V_{CE}=600\text{V}, V_{GE}=0\text{V}$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$	- -	- -	40 2500	$\mu\text{A}$
Gate-emitter leakage current	$I_{GES}$	$V_{CE}=0\text{V}, V_{GE}=20\text{V}$	-	-	100	nA
Transconductance	$g_{fs}$	$V_{CE}=20\text{V}, I_C=20\text{A}$	-	14		S

**Dynamic Characteristic**

Input capacitance	$C_{iss}$	$V_{CE}=25\text{V},$ $V_{GE}=0\text{V},$ $f=1\text{MHz}$	-	1100		pF
Output capacitance	$C_{oss}$		-	105		
Reverse transfer capacitance	$C_{rss}$		-	64		
Gate charge	$Q_{Gate}$	$V_{CC}=480\text{V}, I_C=20\text{A}$ $V_{GE}=15\text{V}$	-	100		nC
Internal emitter inductance measured 5mm (0.197 in.) from case	$L_E$	TO-247AC	-	13		nH
Short circuit collector current <sup>1)</sup>	$I_{C(SC)}$	$V_{GE}=15\text{V}, t_{SC}\leq 10\mu\text{s}$ $V_{CC} \leq 600\text{V},$ $T_j \leq 150^\circ\text{C}$	-	170		A

<sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

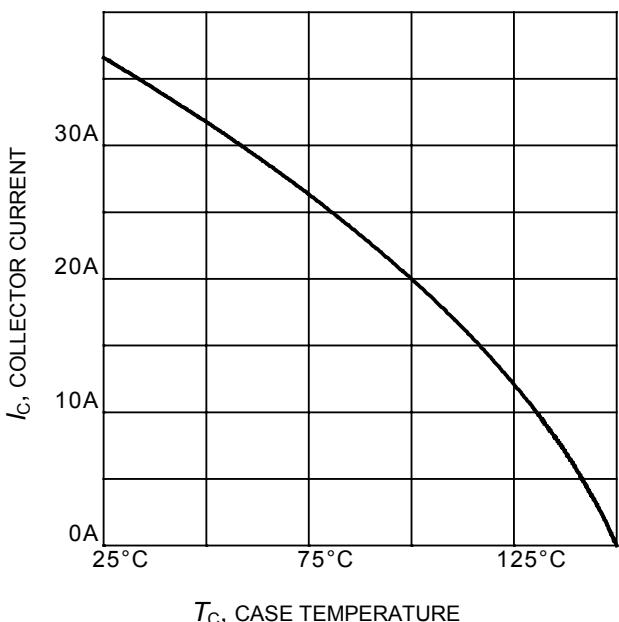
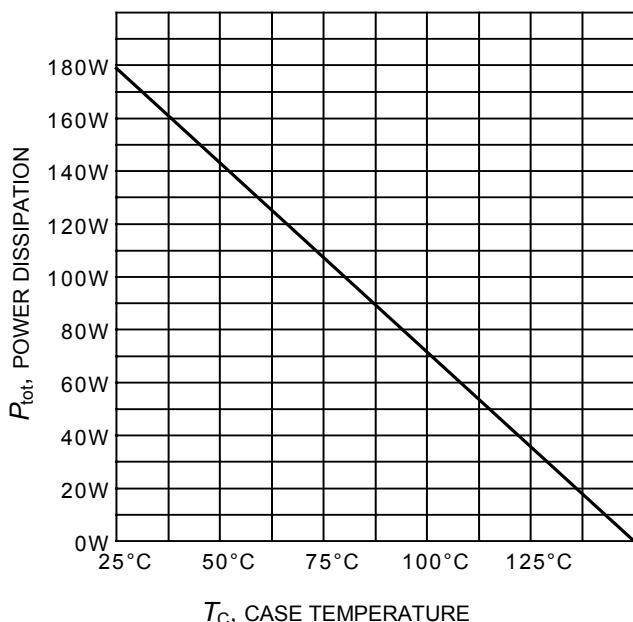
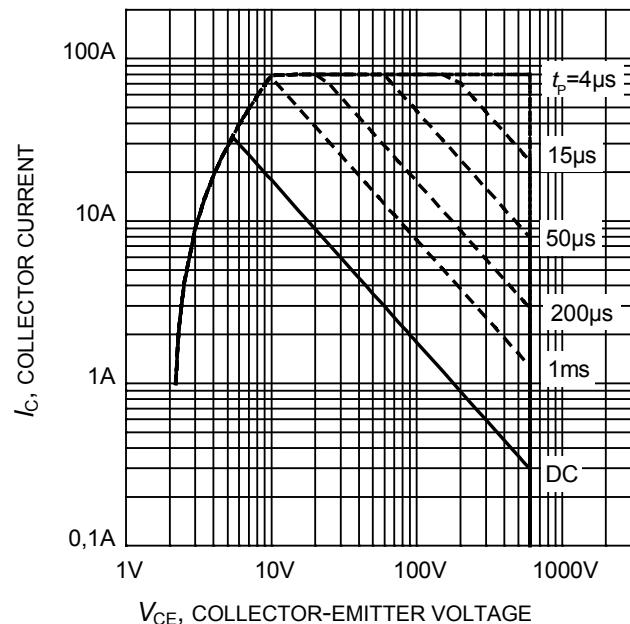
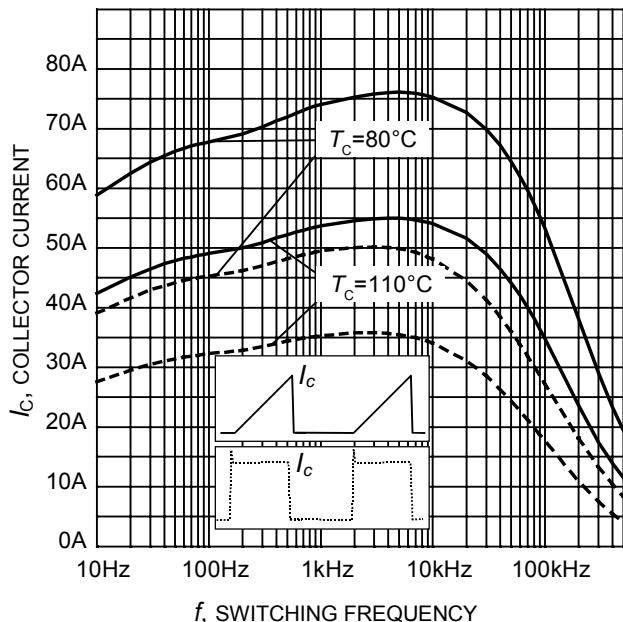
**Switching Characteristic, Inductive Load, at  $T_j=25\text{ }^\circ\text{C}$** 

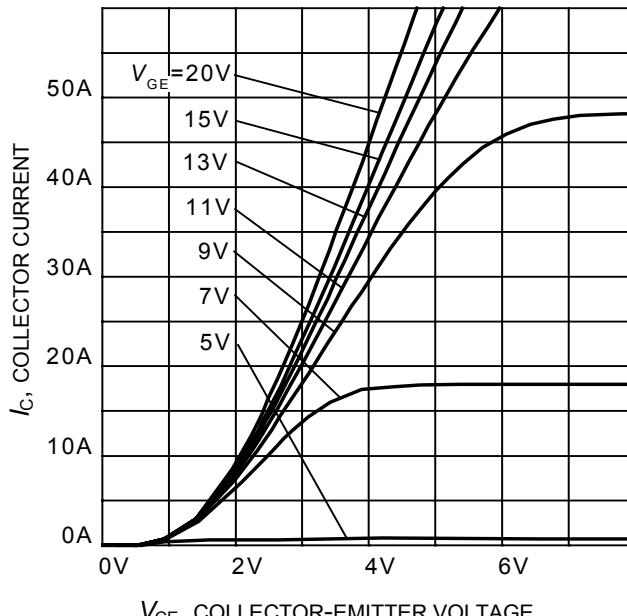
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic</b>						
Turn-on delay time	$t_{d(on)}$	$T_j=25\text{ }^\circ\text{C}$ , $V_{CC}=400\text{V}$ , $I_C=20\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=16\Omega$	-	18		ns
Rise time	$t_r$	$L_\sigma^{(1)}=60\text{nH}$ , $C_\sigma^{(1)}=40\text{pF}$	-	15		
Turn-off delay time	$t_{d(off)}$	$E_\text{losses}$ include "tail" and diode reverse recovery.	-	207		
Fall time	$t_f$		-	13		
Turn-on energy	$E_{on}$		-	0.39		mJ
Turn-off energy	$E_{off}$		-	0.30		
Total switching energy	$E_{ts}$		-	0.69		

**Switching Characteristic, Inductive Load, at  $T_j=150\text{ }^\circ\text{C}$** 

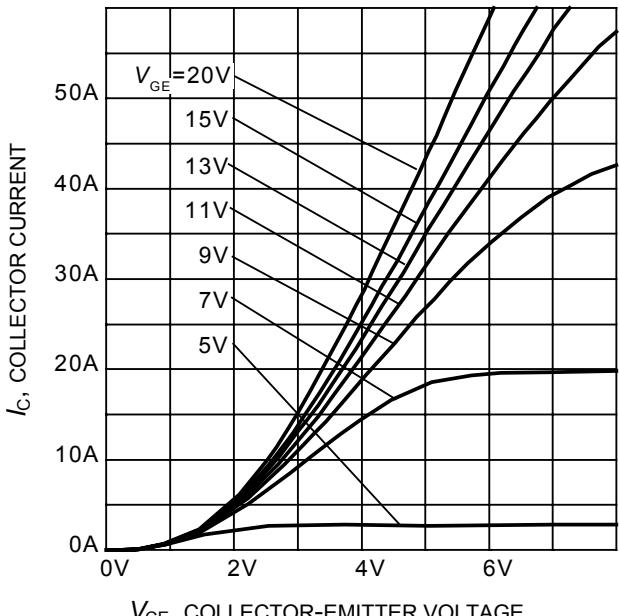
Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	
<b>IGBT Characteristic</b>						
Turn-on delay time	$t_{d(on)}$	$T_j=150\text{ }^\circ\text{C}$ , $V_{CC}=400\text{V}$ , $I_C=20\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=2.2\Omega$	-	15		ns
Rise time	$t_r$	$L_\sigma^{(1)}=60\text{nH}$ , $C_\sigma^{(1)}=40\text{pF}$	-	8.5		
Turn-off delay time	$t_{d(off)}$	$E_\text{losses}$ include "tail" and diode reverse recovery.	-	65		
Fall time	$t_f$		-	35		
Turn-on energy	$E_{on}$		-	0.46		mJ
Turn-off energy	$E_{off}$		-	0.24		
Total switching energy	$E_{ts}$		-	0.7		
Turn-on delay time	$t_{d(on)}$	$T_j=150\text{ }^\circ\text{C}$ , $V_{CC}=400\text{V}$ , $I_C=20\text{A}$ , $V_{GE}=0/15\text{V}$ , $R_G=16\Omega$	-	17		ns
Rise time	$t_r$	$L_\sigma^{(1)}=60\text{nH}$ , $C_\sigma^{(1)}=40\text{pF}$	-	13		
Turn-off delay time	$t_{d(off)}$	$E_\text{losses}$ include "tail" and diode reverse recovery.	-	222		
Fall time	$t_f$		-	13		
Turn-on energy	$E_{on}$		-	0.6		mJ
Turn-off energy	$E_{off}$		-	0.36		
Total switching energy	$E_{ts}$		-	0.96		

<sup>1)</sup> Leakage inductance  $L_\sigma$  and Stray capacity  $C_\sigma$  due to test circuit in Figure E.

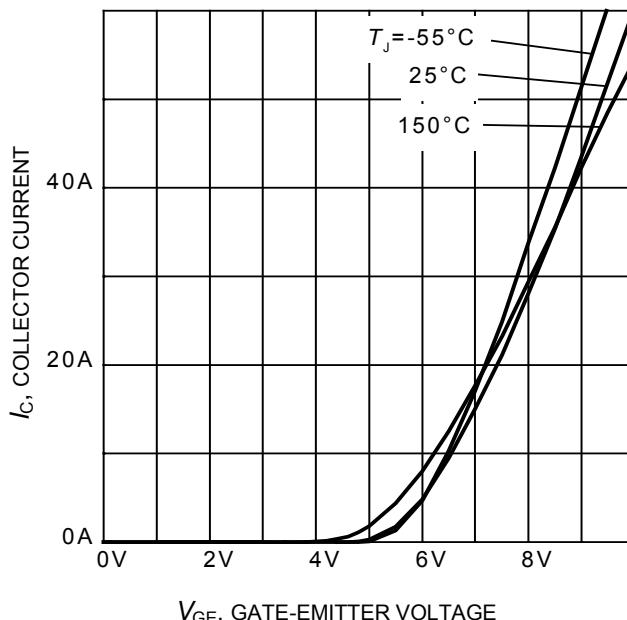




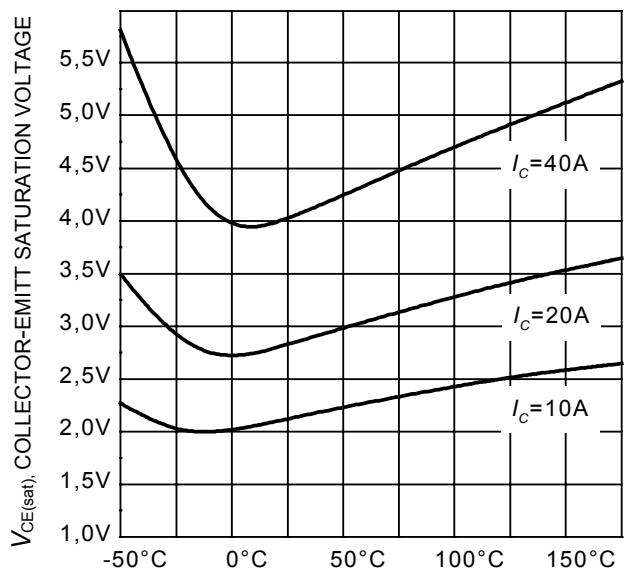
**Figure 5. Typical output characteristic**  
( $T_j = 25^\circ\text{C}$ )



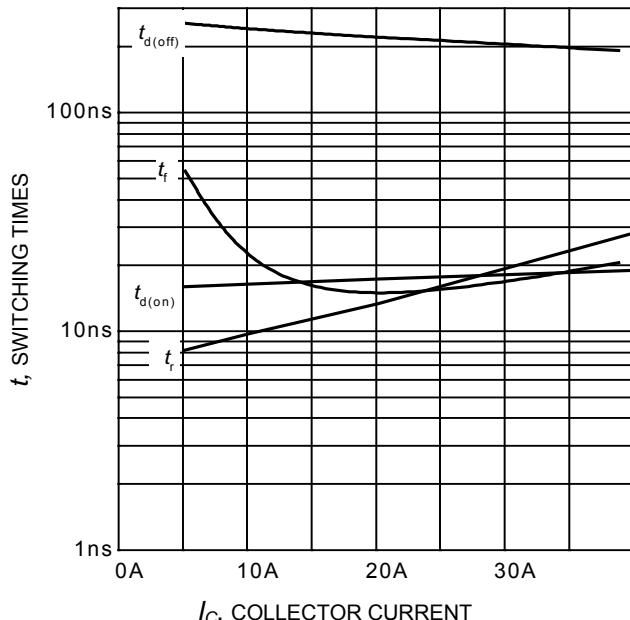
**Figure 6. Typical output characteristic**  
( $T_j = 150^\circ\text{C}$ )



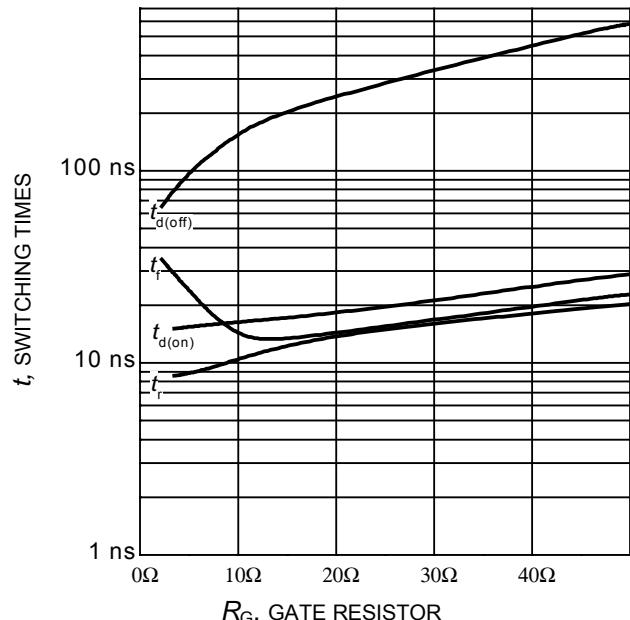
**Figure 7. Typical transfer characteristic**  
( $V_{CE} = 10\text{V}$ )



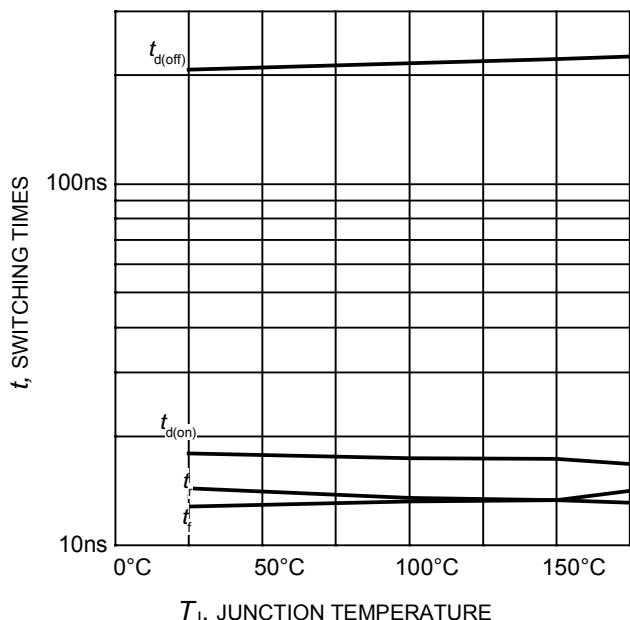
**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15\text{V}$ )



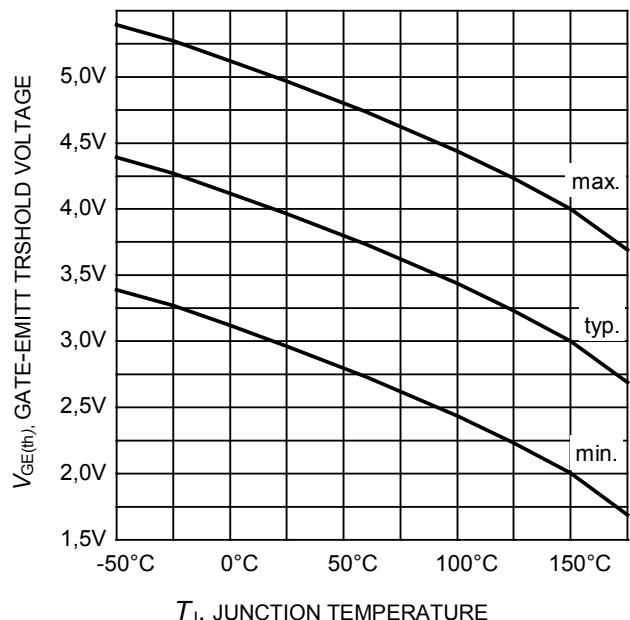
**Figure 9. Typical switching times as a function of collector current**  
(inductive load,  $T_J=150^\circ\text{C}$ ,  
 $V_{CE}=400\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $R_G=16\Omega$ ,  
Dynamic test circuit in Figure E)



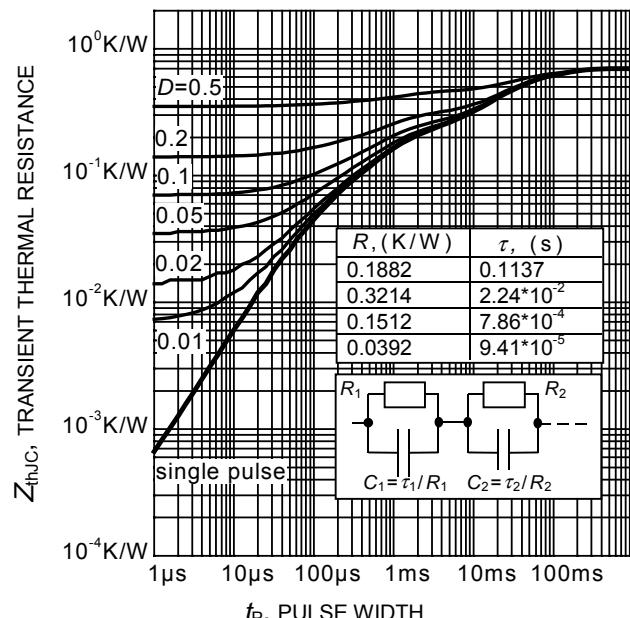
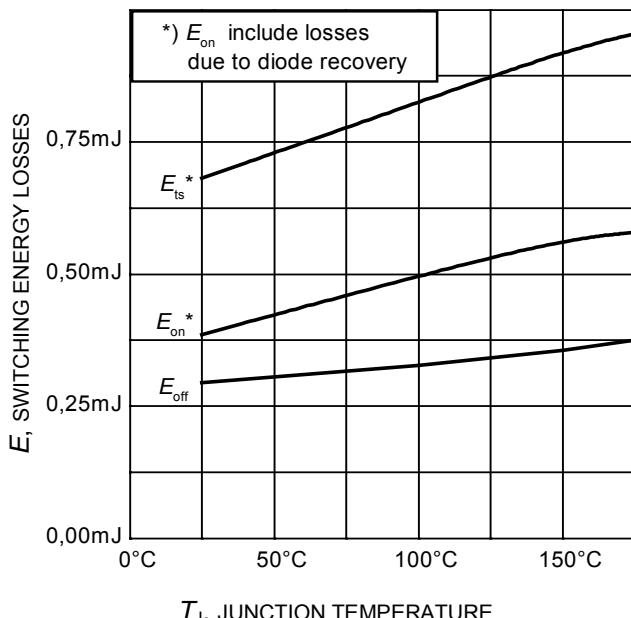
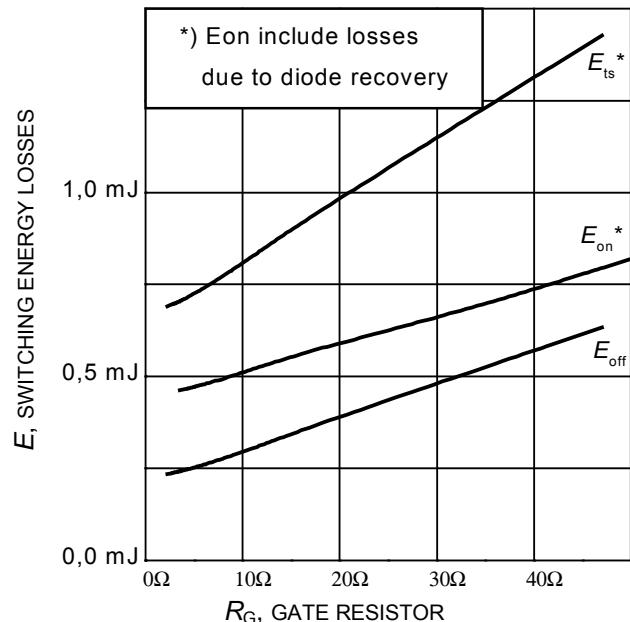
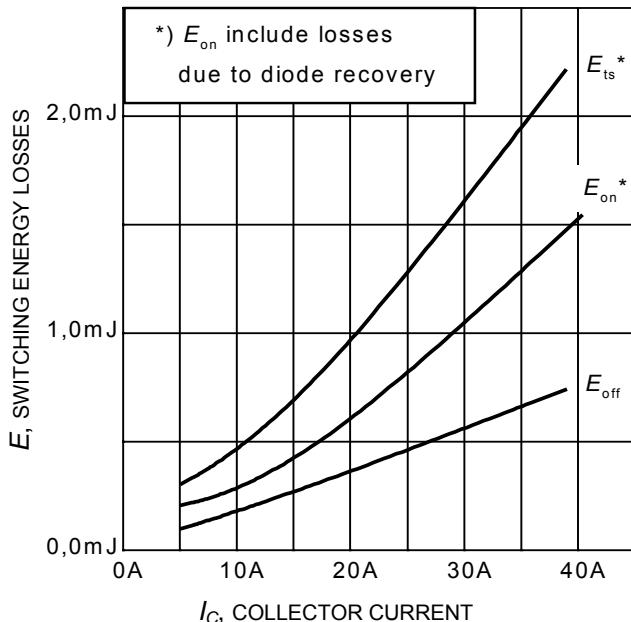
**Figure 10. Typical switching times as a function of gate resistor**  
(inductive load,  $T_J=150^\circ\text{C}$ ,  
 $V_{CE}=400\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=20\text{A}$ ,  
Dynamic test circuit in Figure E)

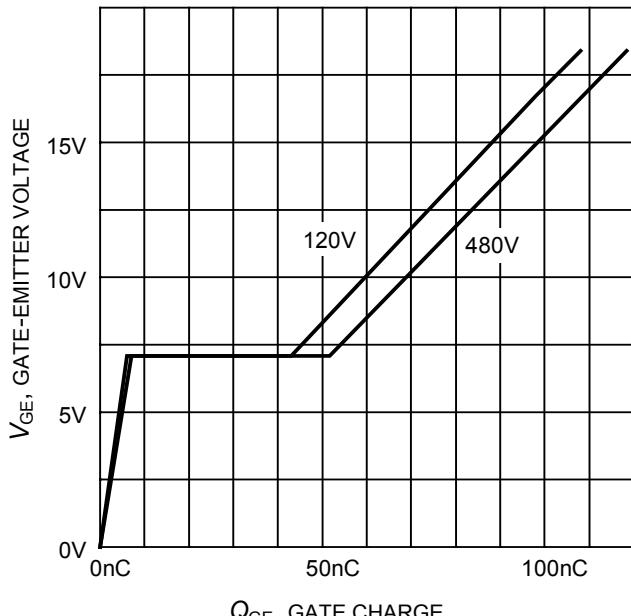


**Figure 11. Typical switching times as a function of junction temperature**  
(inductive load,  $V_{CE}=400\text{V}$ ,  
 $V_{GE}=0/15\text{V}$ ,  $I_C=20\text{A}$ ,  $R_G=16\Omega$ ,  
Dynamic test circuit in Figure E)

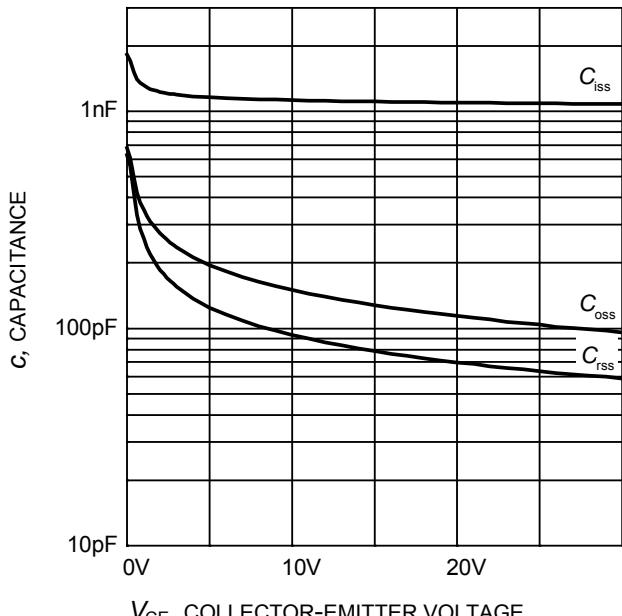


**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**  
( $I_C = 0.5\text{mA}$ )

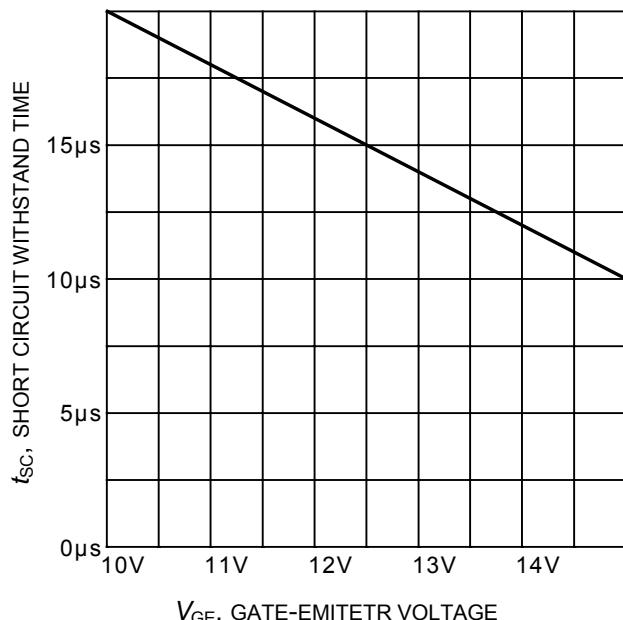




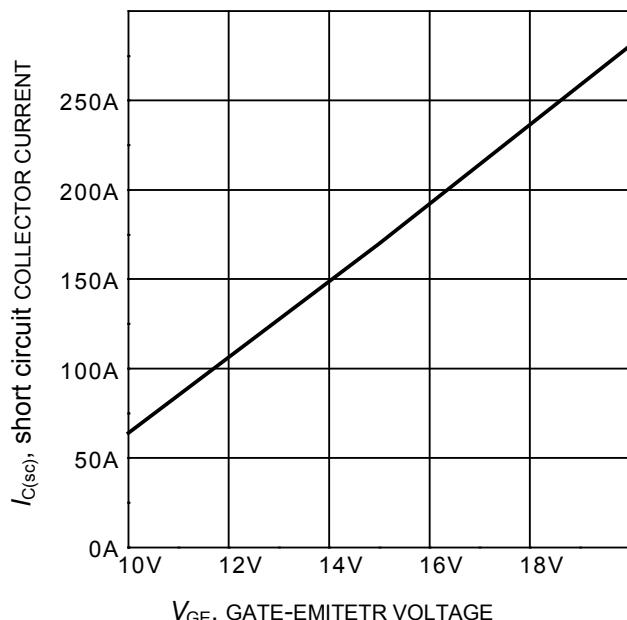
**Figure 17. Typical gate charge**  
( $I_C=20$  A)



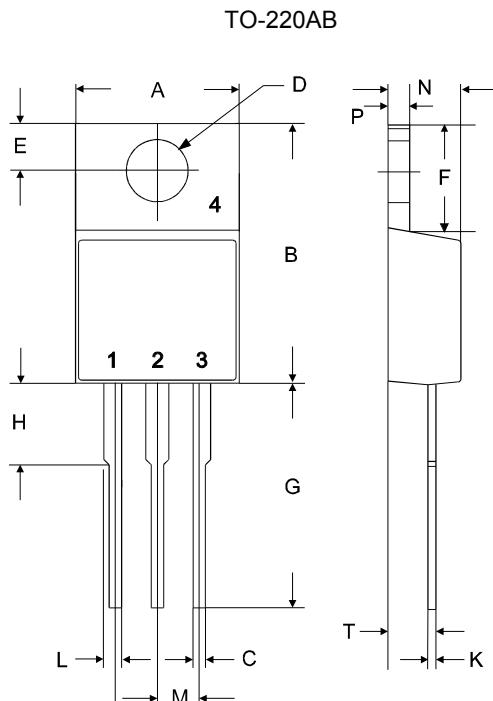
**Figure 18. Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE}=0$  V,  $f = 1$  MHz)



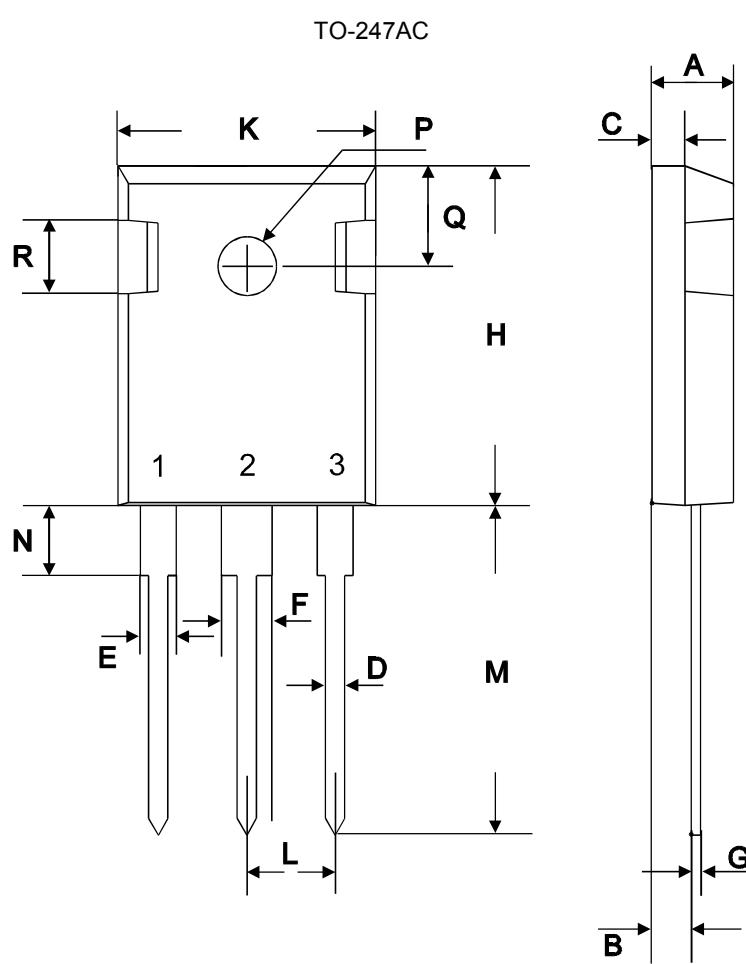
**Figure 19. Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE}=600$  V, start at  $T_j=25$  °C)



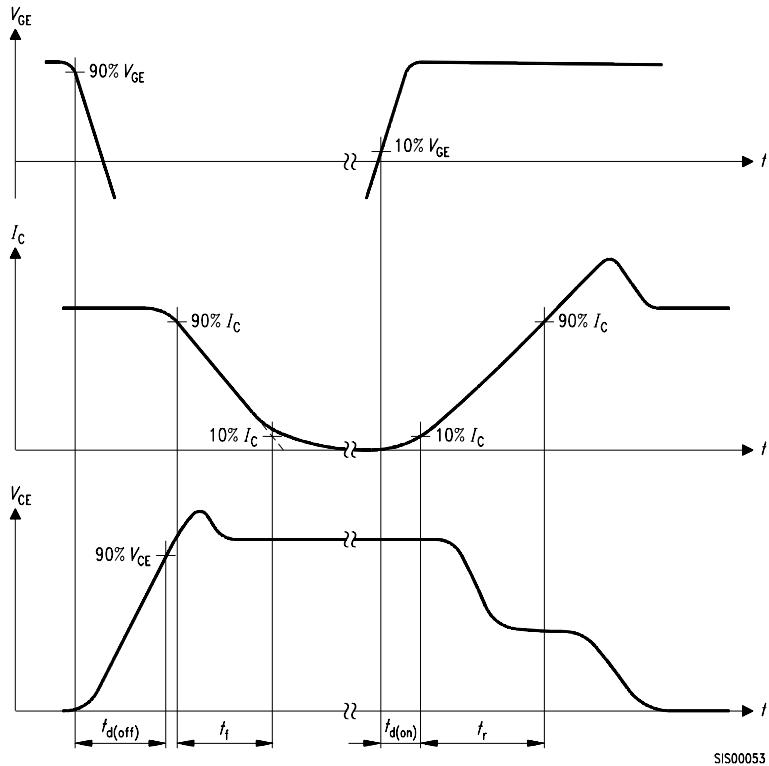
**Figure 20. Typical short circuit collector current as a function of gate-emitter voltage**  
( $V_{CE} \leq 600$  V,  $T_j \leq 150$  °C)



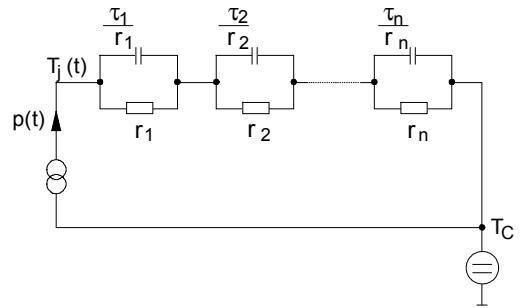
symbol	dimensions			
	[mm]		[inch]	
	min	max	min	max
A	9.70	10.30	0.3819	0.4055
B	14.88	15.95	0.5858	0.6280
C	0.65	0.86	0.0256	0.0339
D	3.55	3.89	0.1398	0.1531
E	2.60	3.00	0.1024	0.1181
F	6.00	6.80	0.2362	0.2677
G	13.00	14.00	0.5118	0.5512
H	4.35	4.75	0.1713	0.1870
K	0.38	0.65	0.0150	0.0256
L	0.95	1.32	0.0374	0.0520
M	2.54 typ.		0.1 typ.	
N	4.30	4.50	0.1693	0.1772
P	1.17	1.40	0.0461	0.0551
T	2.30	2.72	0.0906	0.1071



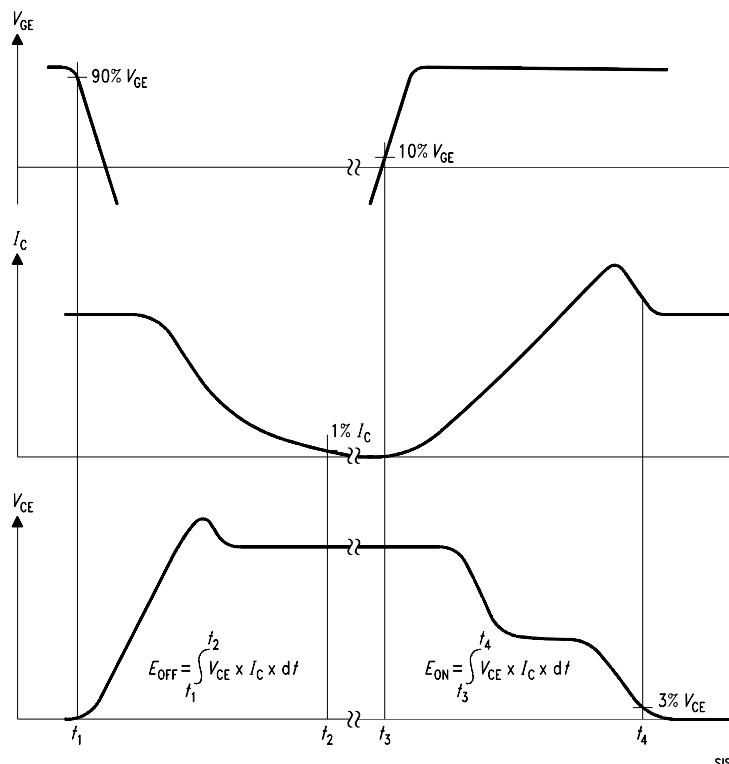
symbol	dimensions			
	[mm]		[inch]	
	min	max	min	max
A	4.78	5.28	0.1882	0.2079
B	2.29	2.51	0.0902	0.0988
C	1.78	2.29	0.0701	0.0902
D	1.09	1.32	0.0429	0.0520
E	1.73	2.06	0.0681	0.0811
F	2.67	3.18	0.1051	0.1252
G	0.76 max		0.0299 max	
H	20.80	21.16	0.8189	0.8331
K	15.65	16.15	0.6161	0.6358
L	5.21	5.72	0.2051	0.2252
M	19.81	20.68	0.7799	0.8142
N	3.560	4.930	0.1402	0.1941
ØP	3.61		0.1421	
Q	6.12	6.22	0.2409	0.2449



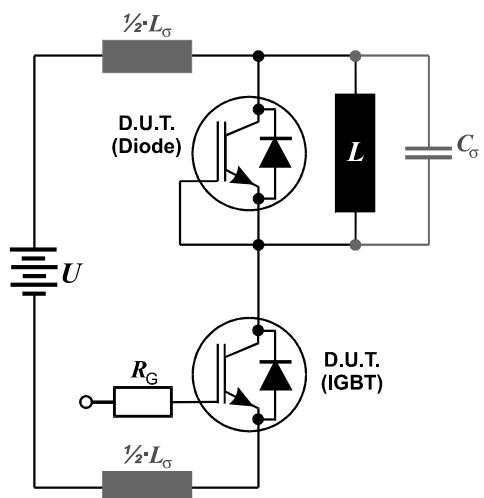
**Figure A. Definition of switching times**



**Figure D. Thermal equivalent circuit**



**Figure B. Definition of switching losses**



**Figure E. Dynamic test circuit**  
Leakage inductance  $L_\sigma = 60\text{nH}$   
and Stray capacity  $C_\sigma = 40\text{pF}$ .



# SGP20N60HS

# SGW20N60HS

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